Safety Precautions for All Tactile Switches

For the individual precautions for a Switch, refer to the safety precautions in the section for that Switch.

<table>
<thead>
<tr>
<th>Precautions for Safe Use</th>
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</thead>
<tbody>
<tr>
<td>Use the Switch within the rated voltage and current ranges, otherwise the Switch may have a shortened life expectancy, radiate heat, or burn out. This particularly applies to the instantaneous voltages and currents when switching.</td>
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<table>
<thead>
<tr>
<th>Precautions for Correct Use</th>
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</thead>
<tbody>
<tr>
<td>Storage</td>
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<tr>
<td>Storage Environment</td>
</tr>
<tr>
<td>To prevent degradation, such as discoloration, in the terminals during storage, do not store the Switch in locations that are subject to the following conditions.</td>
</tr>
<tr>
<td>1. High temperature or humidity</td>
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<tr>
<td>2. Corrosive gases</td>
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<tr>
<td>3. Direct sunlight</td>
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<tr>
<td>Storage condition</td>
</tr>
<tr>
<td>Store the Switches in the packaging box. After the packaging box is opened, use the contents as quickly as possible. When storing leftover parts, make sure that appropriate measures are taken against humidity and corrosive gases.</td>
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</tbody>
</table>

Handling

1. Operation
<table>
<thead>
<tr>
<th>Incorrect</th>
<th>Incorrect</th>
<th>Correct</th>
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</table>

Tactile Switch is not recommended to use for detection purpose due to the sort of Manual Switch. Omron’s Detection Switch is recommended for this purpose.

2. Dust Protection
Do not use Switches that are not sealed in dust-prone environments. Doing so may cause dust to penetrate inside the Switch and cause contact failure. If a Switch that is not sealed must be used in this kind of environment, use a sheet or other measure to protect it against dust.

3. Usage Environment
Before installing the Switch, make sure that the area of installation is not subject to corrosive gases emitted from surrounding parts. Do not use in areas subject to high temperatures, high humidity, or toxic gases such as sulfuric gas (H2S, SO2), ammonia gas (NH3), nitric gas (HNO3), or chlorine gas (Cl2). It can cause corrosive damage to the contacts and result in malfunction.

If there is silicon in the atmosphere, it may stop the contacts from functioning properly.

If silicon products, such as silicon oil, silicon filler, or silicon wires, are used in the surrounding area, install a contact protection circuit to prevent arching or remove the silicon source.

If silicon in the atmosphere may cause water to enter inside the Switch, resulting in a malfunction due to contact failure or corrosion.

- Using the Switch in an outdoor environment where it is exposed to water drops for an extended period of time.
- Using the Switch in an underwater setting where it is subject to strong water pressure.

Do not use Switches that have been dropped. The mating section or other internal parts may be damaged, resulting in malfunction.

PCBs
The Switch is designed for a 1.6-mm thick, single-side PCB. Using PCBs with a different thickness or using double-sided, through-hole PCBs may result in loose mounting, improper insertion, or poor heat resistance in soldering. These effects will occur, depending on the type of holes and patterns of the PCB. Therefore, it is recommended that a verification test is conducted before use.

If the PCBs are separated after mounting the Switch, particles from the PCBs may enter the Switch. If PCB particles or foreign particles from the surrounding environment, workbench, containers, or stacked PCBs become attached to the Switch, contact failure may result.

Soldering

1. General Precautions
Before soldering the Switch on a multilayer PCB, test to confirm that soldering can be performed properly. Otherwise the Switch may be deformed by the soldering heat on the pattern or lands of the multilayer PCB.

Do not solder the Switch more than twice, including rectification soldering. An interval of five minutes is required between the first and the second soldering.

2. Automatic Soldering Baths (B3W)
Soldering temperature: 260°C max.
Soldering time: 5 s max. for a 1.6-mm thick single-side PCB
Preheating temperature: 100°C max. (ambient temperature)
Preheating time: Within 60 s

Make sure that no flux will rise above the level of the PCB. If flux overflows onto the mounting surface of the PCB, it may enter the Switch and cause a malfunction.
3. Reflow Soldering (Surface Mounting)
Solder the terminals within the heating curve shown in the following diagram.

**B3SL, B3AL**

![Heating Curve Diagram](image)

**Note:** The above heating curve applies if the PCB thickness is 1.6 mm.

The peak temperature may vary depending on the reflow bath used. Confirm the conditions beforehand.

Do not use an automatic soldering bath for surface-mounted switches. The soldering gas or flux may enter the switch and damage the switch’s plunger operation.

4. Manual Soldering (All Models)
Soldering temperature: 350°C max. at the tip of the soldering iron
Soldering time: 3 s max. for a 1.6-mm thick, single-side PCB
Before soldering the Switch on a PCB, make sure that there is no unnecessary space between the Switch and the PCB.

Washing

1. Washable and Non-washable Models

<table>
<thead>
<tr>
<th>Washable (sealed types)</th>
<th>B3W</th>
</tr>
</thead>
<tbody>
<tr>
<td>Non-washable (standard types)</td>
<td>B3SL, B3AL</td>
</tr>
</tbody>
</table>

Standard Switches are not sealed, and cannot be washed. Doing so will cause the washing agent, together with flux or dust particles on the PCB, to enter the Switch, resulting in malfunction.

2. Washing Methods
Washing equipment incorporating more than one washing bath can be used to clean washable models, provided that the washable models are cleaned for one minute maximum per bath and the total cleaning time does not exceed three minutes.

3. Washing Agents
Apply alcohol-based solvents to clean washable models. Do not apply any other agents or water to clean any washable model, as such agents may degrade the materials or performance of the Switch.

4. Washing Precautions
Do not impose any external force on washable models while washing. Do not clean washable models immediately after soldering. The cleaning agent may be absorbed into the Switch through respiration as the Switch cools. Wait for at least three minutes after soldering before cleaning washable models.

Do not use Sealed Switches while submerged in water or in locations exposed to water.